

74F00 Quad 2-Input NAND Gate

General Description

This device contains four independent gates, each of which performs the logic NAND function.

Features

- Guaranteed 4000V minimum ESD protection

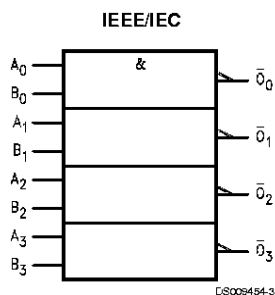
Ordering Code:

Commercial	Military	Package Number	Package Description
74F00PC		N14A	14-Lead (0.300" Wide) Molded Dual-In-Line
	54F00DM (Note 2)	J14A	14-Lead Ceramic Dual-In-Line
74F00SC (Note 1)		M14A	14-Lead (0.150" Wide) Molded Small Outline, JEDEC
74F00SJ (Note 1)		M14D	14-Lead (0.300" Wide) Molded Small Outline, EIAJ
	54F00FM (Note 2)	W14B	14-Lead Cerpack
	54F00LM (Note 2)	E20A	20-Lead Ceramic Leadless Chip Carrier, Type C

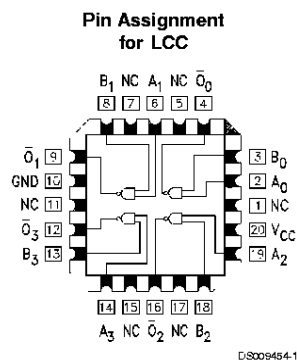
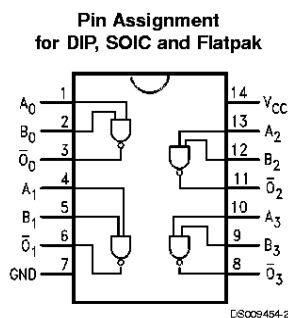
Note 1: Devices also available in 13" reel. Use suffix = SCX and SJX

Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB

Logic Symbol



Connection Diagrams



Unit Loading/Fan Out

Pin Names	Description	54F/74F	
		U.L. HIGH/LOW	Input I_{IH}/I_{IL} Output I_{OH}/I_{OL}
A_n, B_n	Inputs	1.0/1.0	20 μ A/-0.6 mA
\overline{O}_n	Outputs	50/33.3	-1 mA/20 mA

Absolute Maximum Ratings (Note 3)

Storage Temperature	-65°C to +150°C
Ambient Temperature under Bias	-55°C to +125°C
Junction Temperature under Bias	-55°C to +175°C
Plastic	-55°C to +150°C
V _{CC} Pin Potential to Ground Pin	-0.5V to +7.0V
Input Voltage (Note 4)	-0.5V to +7.0V
Input Current (Note 4)	-30 mA to +5.0 mA
Voltage Applied to Output in HIGH State (with V _{CC} = 0V)	
Standard Output	-0.5V to V _{CC}
3-STATE Output	-0.5V to +5.5V
Current Applied to Output	

in LOW State (Max) twice the rated I_{OL} (mA)
ESD Last Passing Voltage (Min) 4000V

Recommended Operating Conditions

Free Air Ambient Temperature	
Commercial	0°C to +70°C
Supply Voltage	
Commercial	+4.5V to +5.5V

Note 3: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

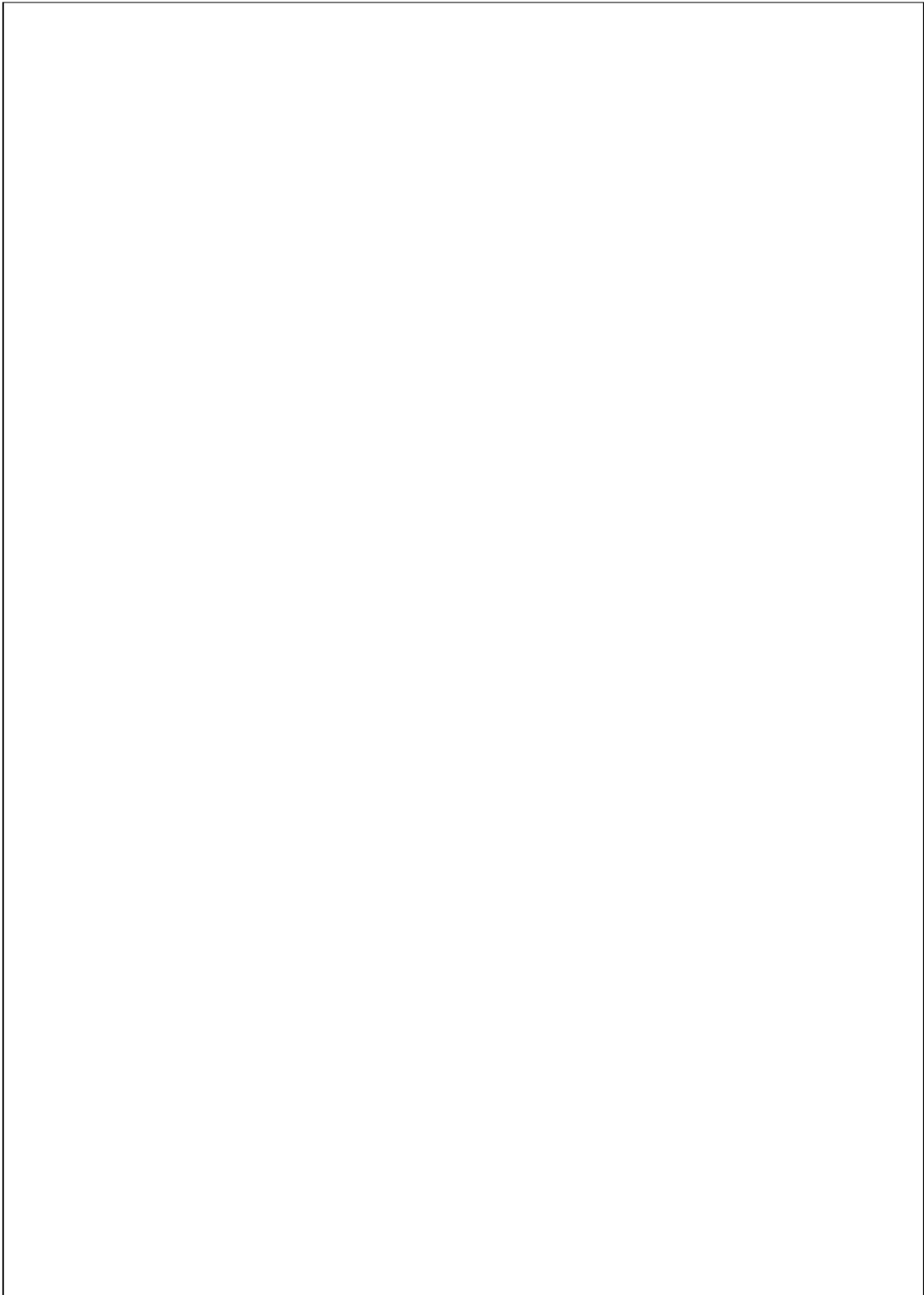
Note 4: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

Symbol	Parameter	54F/74F			Units	V _{CC}	Conditions
		Min	Typ	Max			
V _{IH}	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V _{IL}	Input LOW Voltage				V		Recognized as a LOW Signal
V _{CD}	Input Clamp Diode Voltage				V	Min	I _{IN} = -18 mA
V _{OH}	Output HIGH Voltage	54F 10% V _{CC}	2.5		V	Min	I _{OH} = -1 mA
		74F 10% V _{CC}	2.5				I _{OH} = -1 mA
		74F 5% V _{CC}	2.7				I _{OH} = -1 mA
V _{OL}	Output LOW Voltage	54F 10% V _{CC}			V	Min	I _{OL} = 20 mA
		74F 10% V _{CC}					I _{OL} = 20 mA
I _{IH}	Input HIGH Current	54F	20.0		μA	Max	V _{IN} = 2.7V
		74F	5.0				
I _{BVI}	Input HIGH Current Breakdown Test	54F	100		μA	Max	V _{IN} = 7.0V
		74F	7.0				
I _{CEX}	Output HIGH Leakage Current	54F	250		μA	Max	V _{OUT} = V _{CC}
		74F	50				
V _{ID}	Input Leakage Test	74F	4.75		V	0.0	I _{ID} = 1.9 μA All other pins grounded
I _{OD}	Output Leakage Circuit Current	74F	3.75		μA	0.0	V _{IOD} = 150 mV All other pins grounded
I _{IL}	Input LOW Current				mA	Max	V _{IN} = 0.5V
I _{OS}	Output Short-Circuit Current	-60			mA	Max	V _{OUT} = 0V
I _{CCH}	Power Supply Current	1.9			mA	Max	V _O = HIGH
I _{CCL}	Power Supply Current	6.8			mA	Max	V _O = LOW

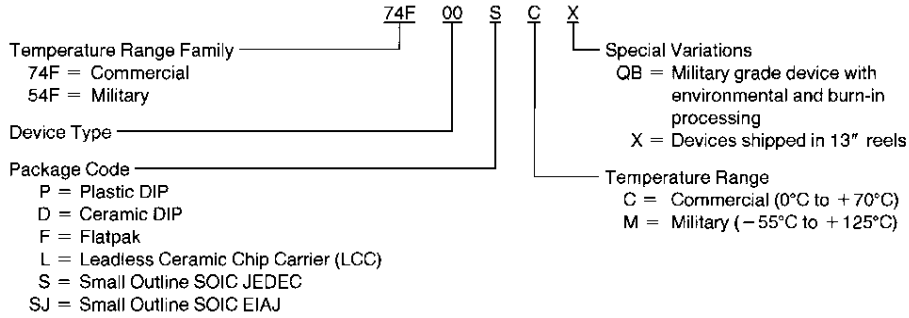
AC Electrical Characteristics

Symbol	Parameter	74F			54F		74F		Units
		T _A = +25°C V _{CC} = +5.0V C _L = 50 pF			T _A , V _{CC} = MII C _L = 50 pF		T _A , V _{CC} = Com C _L = 50 pF		
		Min	Typ	Max	Min	Max	Min	Max	
t _{PLH}	Propagation Delay	2.4	3.7	5.0	2.0	7.0	2.4	6.0	ns
t _{PHL}	A _n , B _n to \bar{O}_n	1.5	3.2	4.3	1.5	6.5	1.5	5.3	



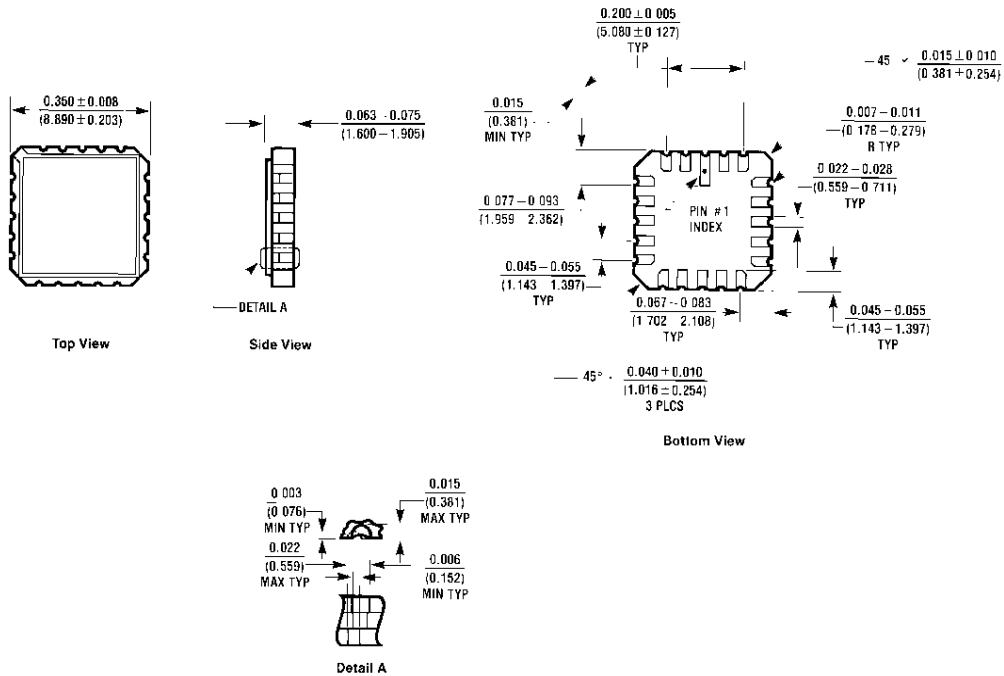
Ordering Information

The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:



D8009454-4

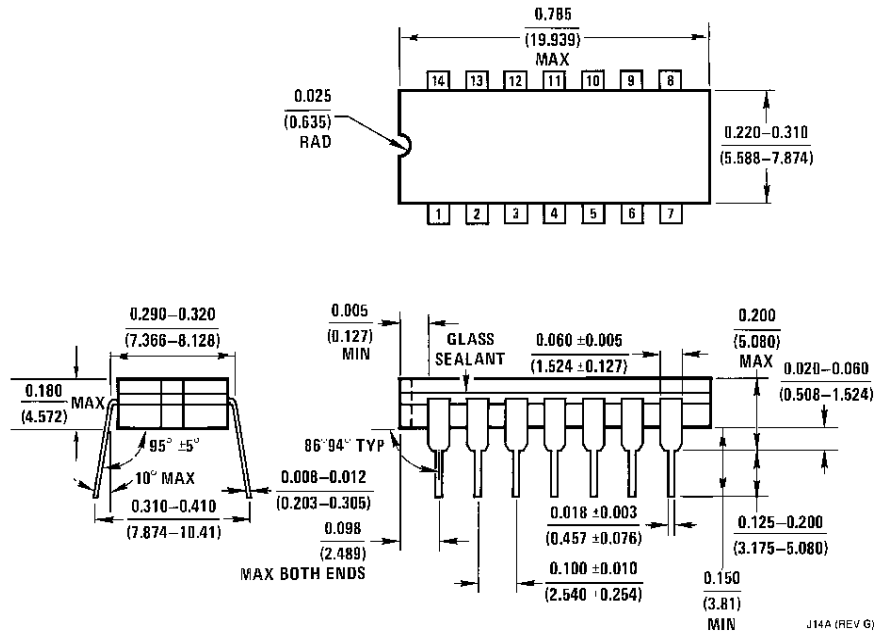
Physical Dimensions inches (millimeters) unless otherwise noted



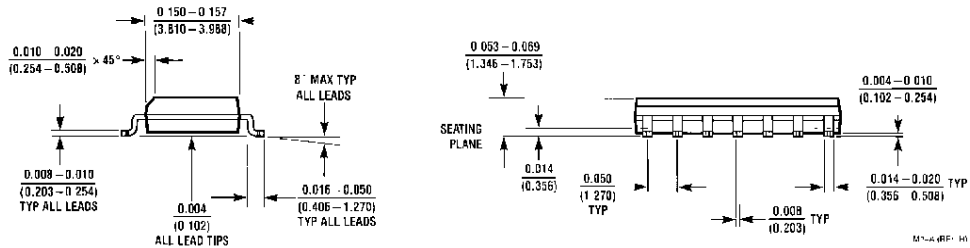
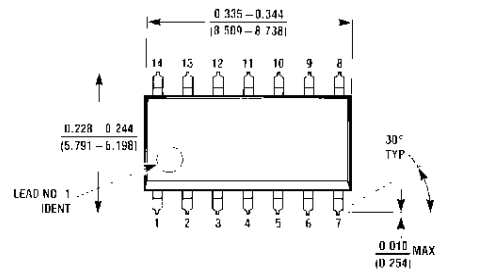
E0-AIRBY-1

**20-Lead Ceramic Leadless Chip Carrier (L)
 NS Package Number E20A**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

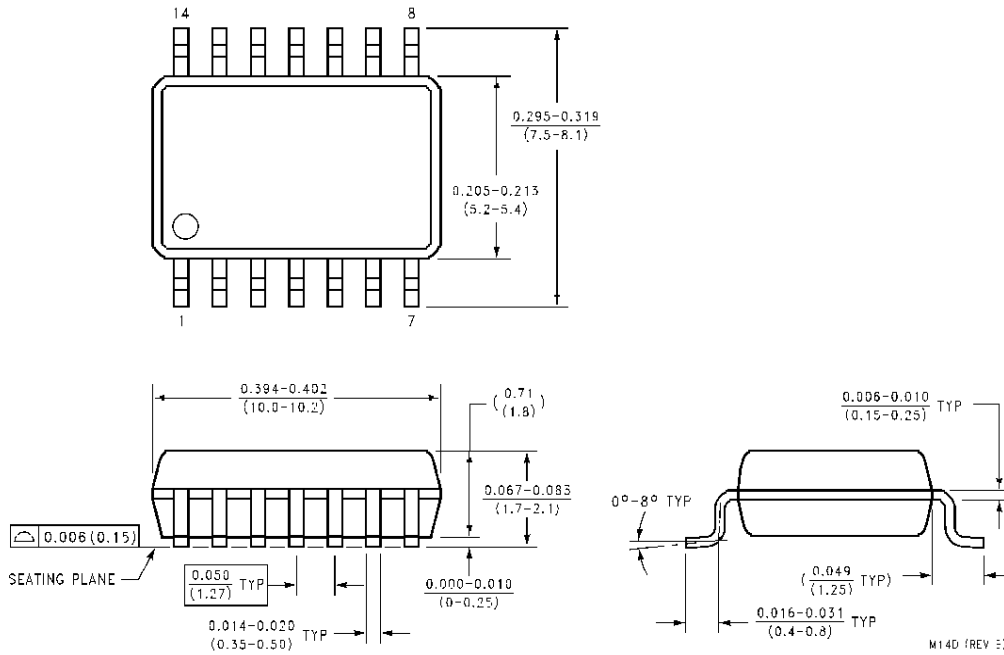


14-Lead Ceramic Dual-In-Line Package (D)
NS Package Number J14A

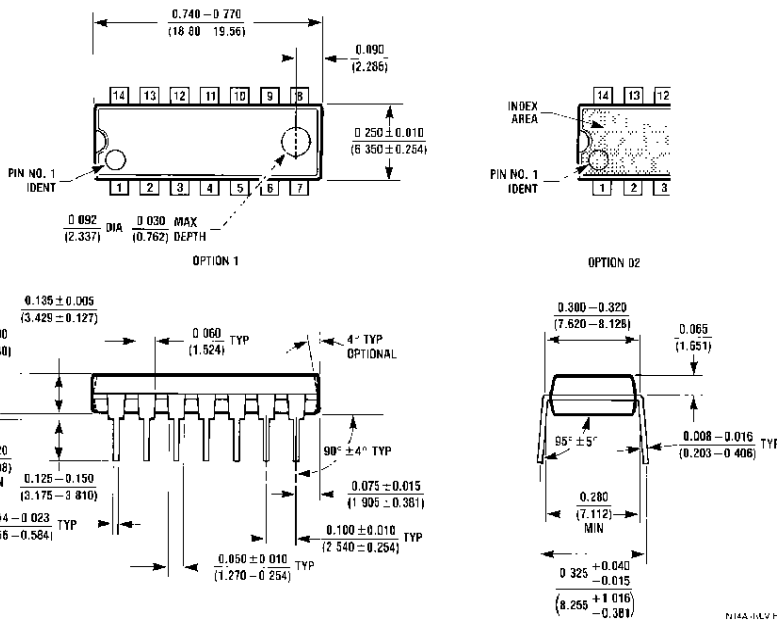


14-Lead (0.150" Wide) Molded Small Outline Package, JEDEC (S)
NS Package Number M14A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

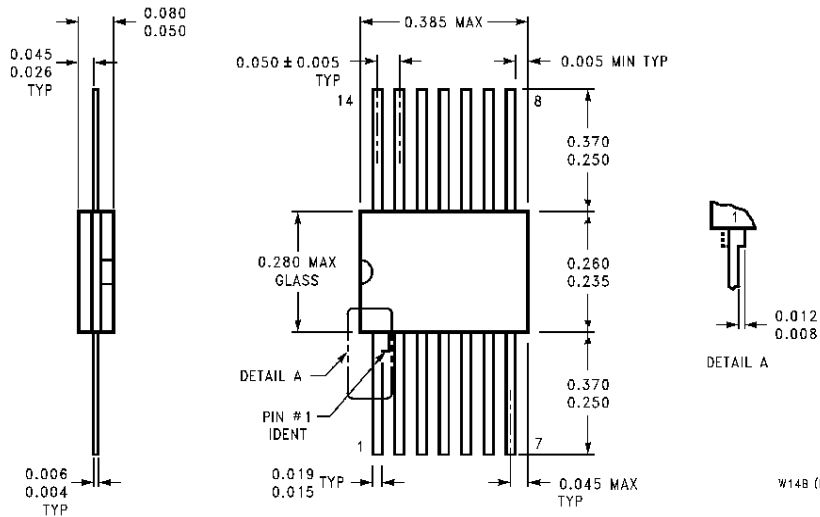


**14-Lead (0.300" Wide) Molded Small Outline Package, EIAJ (SJ)
NS Package Number M14D**



**14-Lead (0.300" Wide) Molded Dual-In-Line Package (P)
NS Package Number N14A**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



**14-Lead Ceramic Flatpak (F)
NS Package Number W14B**

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Fairchild Semiconductor
Corporation
Americas
Customer Response Center
Tel 1-888-522-5372

www.fairchildsemi.com

Fairchild Semiconductor
Europe
Fax +49 (0) 1 80-530 85 86
Email europe.support@nsc.com
Deutsch Tel +49 (0) 6 141-35-0
English Tel +44 (0) 1 793-85-66-56
Italy Tel +39 (0) 2 57 5631

Fairchild Semiconductor
Hong Kong Ltd.
13th Floor, Straight Block,
Ocean Centre, 5 Canton Rd
Tsimshatsui, Kowloon
Hong Kong
Tel +852 2737-7200
Fax +852 2314-0061

National Semiconductor
Japan Ltd.
Tel 81-3-5620-6175
Fax 81-3-5620-6179